

LINEAR IC CMOS

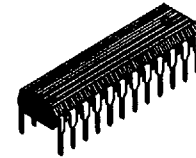
8 BIT 4-CHANNEL D/A CONVERTER

MB86023

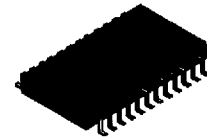
CMOS 8-BIT 4-CHANNEL D/A CONVERTER

The Fujitsu MB86023 is a 8-bit 4-channel Digital to Analog Converter which is fabricated with Fujitsu CMOS Technology. The data latch and output buffer circuitry are provided on each channel which can operate independently selected by 2bit data.

- Resolution : 8-Bits (4-channels)
- Conversion Rate : 500k sps
- Digital Input Voltage : TTL Level
- Power Supply Voltage : $\pm 5V$
- Low Power Dissipation : 80mW typ. at $\pm 5V$
- Each channel operates independently
- On-chip Data Initialization & Power Down Function
- Reference voltage mode selection: On-chip or External generation
- Easy to take interface with micro processor (Parallel Data Input)



PLASTIC PACKAGE
DIP-24P-M03



PLASTIC PACKAGE
FPT-24P-M02

PIN ASSIGNMENT

(TOP VIEW)

D0	1	24	RESET
D1	2	23	PD
D2	3	22	V _{DD}
D3	4	21	NC
D4	5	20	VR
D5	6	19	AO0
D6	7	18	AO1
D7	8	17	AO2
C0	9	16	AO3
C1	10	15	V _{SS}
WR	11	14	AG
CE	12	13	DG

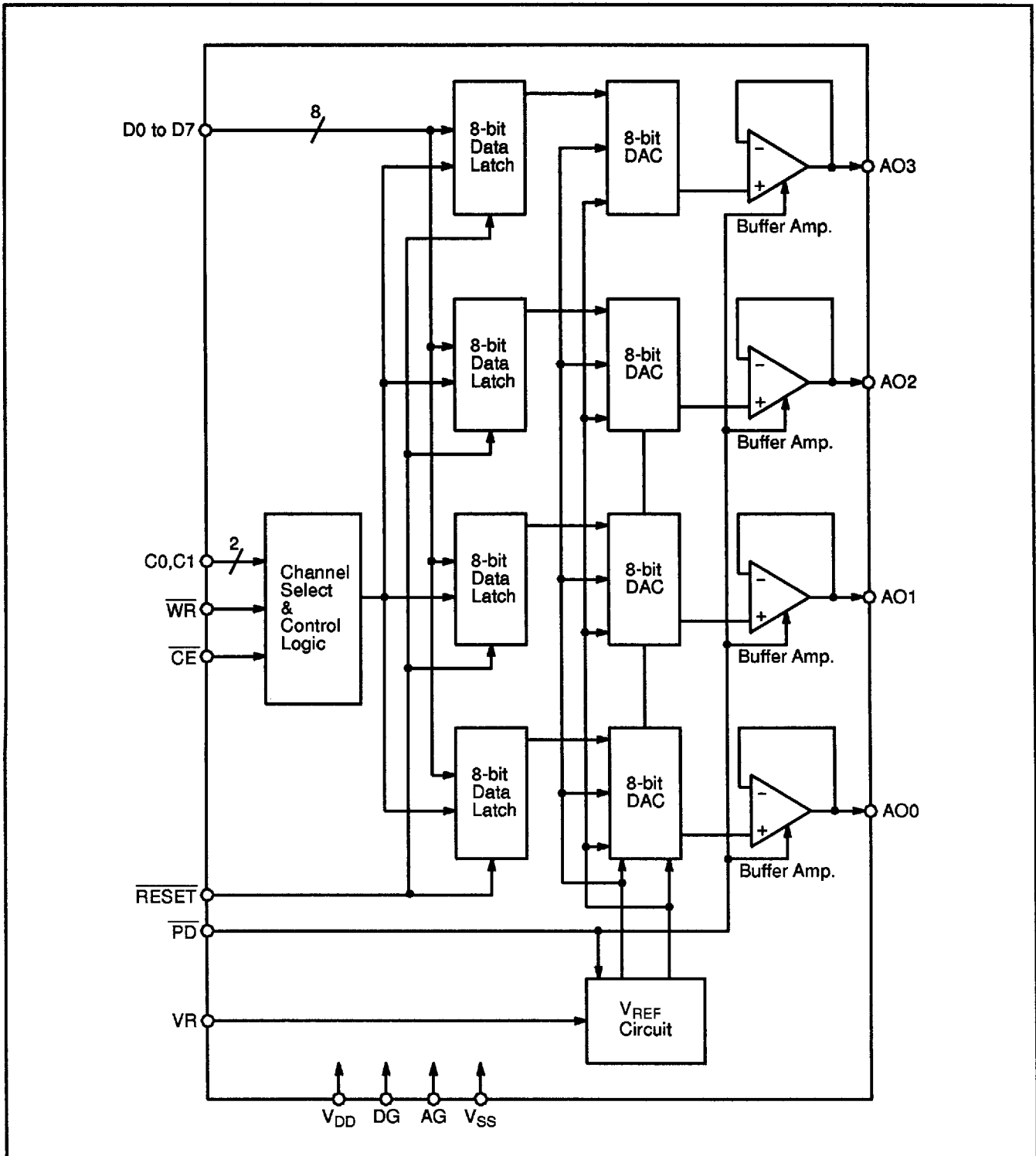
This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields. However, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit.

ABSOLUTE MAXIMUM RATINGS (See NOTE)

Parameter	Symbol	Pin Name	Rating			Unit
			Min	Typ	Max	
Power supply voltage1	V_{DD}	V_{DD}	GND-0.3	-	7	V
Power supply voltage2	V_{SS}	V_{SS}	-7	-	GND+0.3	V
Digital input voltage	V_{DI}	All digital input pins	GND-0.3	-	$V_{DD}+0.3$	V
Analog input voltage	V_{AI}	VR	$V_{SS}-0.3$	-	$V_{DD}+0.3$	V
Analog output voltage	V_{AO}	AO0,AO1,AO2,AO3	$V_{SS}-0.3$	-	$V_{DD}+0.3$	V
Pin current (Except power supply pin)	I_{TO}	Except V_{DD} , V_{SS} pin	-10	-	10	mA
Power supply current	I_{PO}	V_{DD} , V_{SS}	-30	-	30	mA
Storage temperature	T_{stg}		-40	-	125	°C

NOTE: Permanent device damage may occur if the above **Absolute Maximum Ratings** are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

BLOCK DIAGRAM



PIN DESCRIPTION

System	Pin Number	Symbol	Descriptions															
Power Supply	22	V _{DD}	Power supply voltage 5V															
	15	V _{SS}	Power supply voltage -5V															
	13	DG	GND for Digital System															
	14	AG	GND for Analog System															
Digital Input	23	$\overline{\text{PD}}$	Power down control signal pin. The circuit is set power down when this pin goes to "L". This pin is pulled up by high resistance. TTL interface.															
	24	$\overline{\text{RESET}}$	Reset input signal pin. The data at all channels is initialized when this pin goes to "L". At this time, the D/A output is set at D(A)=128. This pin is pulled up by high resistance. TTL interface.															
	12	$\overline{\text{CE}}$	Chip enable signal pin. The data can be written when this pin goes to "L". This pin is pulled up by high resistance. TTL interface.															
	11	$\overline{\text{WR}}$	Data write pin. The data from D0 to D7 is written when the rising edge (L → H) of this pin. TTL interface.															
	9	C0	Channel selection signal pin. Channels are selected by following table. TTL interface. <table border="1" style="margin: 10px auto;"> <thead> <tr> <th>C1</th> <th>C0</th> <th>Channel</th> </tr> </thead> <tbody> <tr> <td>L</td> <td>L</td> <td>0</td> </tr> <tr> <td>L</td> <td>H</td> <td>1</td> </tr> <tr> <td>H</td> <td>L</td> <td>2</td> </tr> <tr> <td>H</td> <td>H</td> <td>3</td> </tr> </tbody> </table>	C1	C0	Channel	L	L	0	L	H	1	H	L	2	H	H	3
	C1	C0		Channel														
	L	L	0															
	L	H	1															
	H	L	2															
	H	H	3															
	10	C1																
	1	D0	Data input signal pin. The digital data is read by the channel which is selected by C0 and C1 pin when the rising edge of $\overline{\text{WR}}$ (L → H), and analog output is shown correspond to that digital code. D0 is LSB and D7 is MSB. Code is set at 10000000 when reset. TTL interface.															
	2	D1																
3	D2																	
4	D3																	
5	D4																	
6	D5																	
7	D6																	
8	D7																	
Analog Input	20	VR	Reference voltage (H level) input pin. $\frac{1}{2}V_{DD}$ is given by internal reference voltage circuitry to this pin when internal reference voltage mode. In this case, the capacitor between this pin and AG pin is required to limit noise generation. In case of external reference voltage mode, the reference voltage should be given from this pin.															
Analog Output	21	N. C	Non connection pin															
	16	AO3	Analog output pin of channel 3. This pin is set to high-impedance state at Power Down.															
	17	AO2	Analog output pin of channel 2. This pin is set to high-impedance state at Power Down.															
	18	AO1	Analog output pin of channel 1. This pin is set to high-impedance state at Power Down.															
	19	AO0	Analog output pin of channel 0. This pin is set to high-impedance state at Power Down.															

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Pin Name	Value			Unit
			Min	Typ	Max	
Power supply voltage1	V_{DD}	V_{DD}	4.75	5.0	5.25	V
Power supply voltage2	V_{SS}	V_{SS}	-5.25	-5.0	-4.75	V
Digital input voltage	V_{DI}	All digital input pins	0	-	V_{DD}	V
Analog input voltage	V_I	VR	-3.0	2.5	3.0	V
Analog output load current	I_{AL}	AO0, AO1, AO2, AO3	-1	-	1	mA
Analog output load capacitance	C_{AL}		-	-	30	pF
Operating temperature	T_a		-20	-	70	°C

ELECTRICAL CHARACTERISTICS

(V_{DD}=4.75V to 5.25V, V_{SS}=-5.25V to -4.75V, Ta=-20°C to 70°C)

Parameter	Symbol	Pin Name	Conditions	Value			Unit	
				Min	Typ	Max		
Power supply current 1	I _{DD1}	V _{DD}	No load	PD="H"	-	8	16	mA
	I _{DD2}			PD="L"	-	-	0.5	mA
Power supply current 2	I _{SS1}	V _{SS}		PD="H"	-16	-8	-	mA
	I _{SS2}			PD="L"	-0.5	-	-	mA
Digital input	"L" Voltage	V _{IL}	All digital input pins		0	-	0.8	V
	"H" Voltage	V _{IH}			2.2	-	V _{DD}	V
	"L" Current	I _{IL}	D0 to D7, \overline{WR}	V _{Dl} =GND	-10	-	10	μA
	"H" Current	I _{IH}		V _{Dl} =V _{DD}	-10	-	10	μA
Pull up current	I _{PLU}	$\overline{PD}, \overline{CE}, \overline{RESET}$	V _{Dl} =GND	-100	-50	-25	μA	
\overline{WR} "H" Width	t _{WHWR}	\overline{WR}	Ref. to timing chart	200	-	-	ns	
\overline{WR} "L" Width	t _{WLWR}	\overline{WR}	Ref. to timing chart	200	-	-	ns	
Digital input "L" width	t _{WLRP}	$\overline{RESET}, \overline{PD}$	Ref. to timing chart	500	-	-	ns	
DATA Set up time 1	t _{SD1}	D0 to D7, \overline{WR}	Ref. to timing chart	200	-	-	ns	
DATA Set up time 2	t _{SD2}	C0, C1, \overline{WR}	Ref. to timing chart	200	-	-	ns	
\overline{CE} Set up time	t _{SCE}	$\overline{CE}, \overline{WR}$	Ref. to timing chart	0	-	-	ns	
DATA Hold time 1	t _{HD1}	D0 to D7, \overline{WR}	Ref. to timing chart	50	-	-	ns	
DATA Hold time 2	t _{HD2}	C0, C1, \overline{WR}	Ref. to timing chart	50	-	-	ns	
\overline{CE} Hold time	t _{HCE}	$\overline{CE}, \overline{WR}$	Ref. to timing chart	0	-	-	ns	


(Continued)

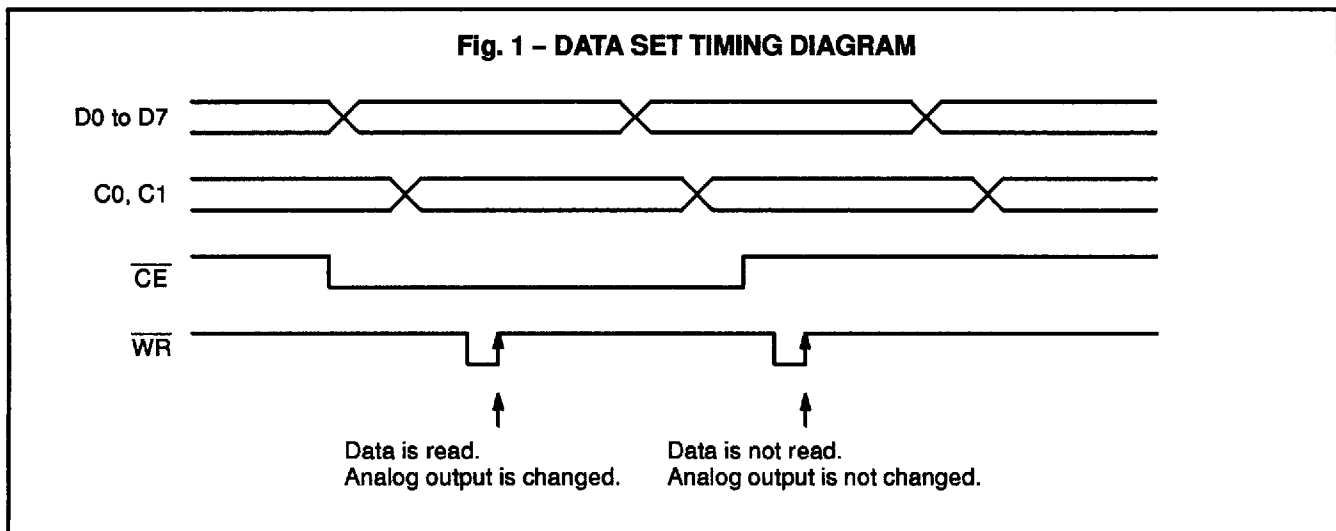
(V_{DD}=4.75V to 5.25V, V_{SS}=-5.25V to -4.75V, T_a=-20°C to 70°C)

Parameter	Symbol	Pin Name	Conditions	Value			Unit
				Min	Typ	Max	
Rising time 1	t _{r1}	\overline{WR}	Ref. to timing chart	0	-	50	ns
Falling time 1	t _{f1}	\overline{WR}	Ref. to timing chart	0	-	50	ns
Rising time 2	t _{r2}	D0 to D7, C0, C1, \overline{CE} , \overline{RESET} , \overline{PD}	Ref. to timing chart	0	-	50	ns
Falling time 2	t _{f2}	D0 to D7, C0, C1, \overline{CE} , \overline{RESET} , \overline{PD}	Ref. to timing chart	0	-	50	ns
Resolution	Res				8	-	Bits
Analog output Min. voltage	V _{AOL}	AO0, AO1, AO2, AO3	Input Code D(A)= 0 No external VR input VR=open	(Typ.) -0.1	$-\frac{255}{512} \times V_{DD}$	(Typ.)+0.1	V
Analog output Max. voltage	V _{AOH}		Input Code D(A)= 255 No external VR input VR=open	(Typ.) -0.1	$\frac{255}{512} \times V_{DD}$	(Typ.)+0.1	V
Analog input resistance	R _{IN}	VR		30	50	200	kΩ
Linearity error	LE	AO0, AO1, AO2, AO3	No external VR input VR=open	-1.5	-	1.5	LSB
Differential linearity error	D _{LE}			-1	-	1	LSB
Setting time	t _S		Full scale change (Ref. to timing chart)	-	-	2	μs
Analog output rising time falling time	t _r t _f		Input Code D(A)=255 VR=±2 Square wave input (Ref. to timing chart)	-	-	1.5	μs

FUNCTION DESCRIPTION

TRUTH TABLE

$\overline{\text{PD}}$	$\overline{\text{RESET}}$	$\overline{\text{CE}}$	$\overline{\text{WR}}$	C0, C1	D0 to D7	Function
0	x	x	x	-	-	Power down
1	0	x	x	-	-	Initialization
1	1	1	x	-	No data input	No analog output change
1	1	0		Channel Selection	Data input	Analog output change



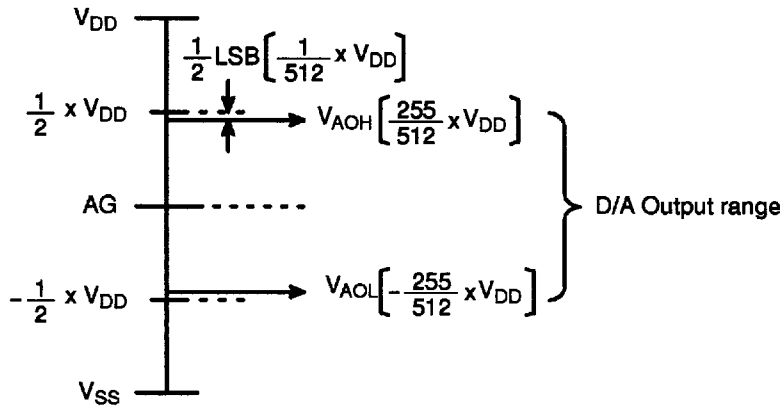
SETTING OF ANALOG OUTPUT VOLTAGE

Data									Analog Output Voltage	
D(A)	D7	D6	D5	D4	D3	D2	D1	D0	V_R Open (No External Input)	$V_R=V_1$ (External Input)
255	1	1	1	1	1	1	1	1	$\frac{255}{512} \times V_{DD}$	$\frac{255}{256} \times V_1$
254	1	1	1	1	1	1	1	0	$\frac{253}{512} \times V_{DD}$	$\frac{253}{256} \times V_1$
253	1	1	1	1	1	1	0	1	$\frac{251}{512} \times V_{DD}$	$\frac{251}{256} \times V_1$
⋮									$\frac{V_{DD}}{512} \times (2D(A) - 255)$	$\frac{V_1}{256} \times (2D(A) - 255)$
129	1	0	0	0	0	0	0	1	$\frac{3}{512} \times V_{DD}$	$\frac{3}{256} \times V_1$
128	1	0	0	0	0	0	0	0	$\frac{1}{512} \times V_{DD}$	$\frac{1}{256} \times V_1$
127	0	1	1	1	1	1	1	1	$-\frac{1}{512} \times V_{DD}$	$-\frac{1}{256} \times V_1$
126	0	1	1	1	1	1	1	0	$-\frac{3}{512} \times V_{DD}$	$-\frac{3}{256} \times V_1$
⋮									⋮	⋮
2	0	0	0	0	0	0	1	0	$-\frac{251}{512} \times V_{DD}$	$-\frac{251}{256} \times V_1$
1	0	0	0	0	0	0	0	1	$-\frac{253}{512} \times V_{DD}$	$-\frac{253}{256} \times V_1$
0	0	0	0	0	0	0	0	0	$-\frac{255}{512} \times V_{DD}$	$-\frac{255}{256} \times V_1$
1LSB									$\frac{1}{256} \times V_{DD}$	$\frac{1}{128} \times V_1$

* Code is set at "1000000" when reset mode.

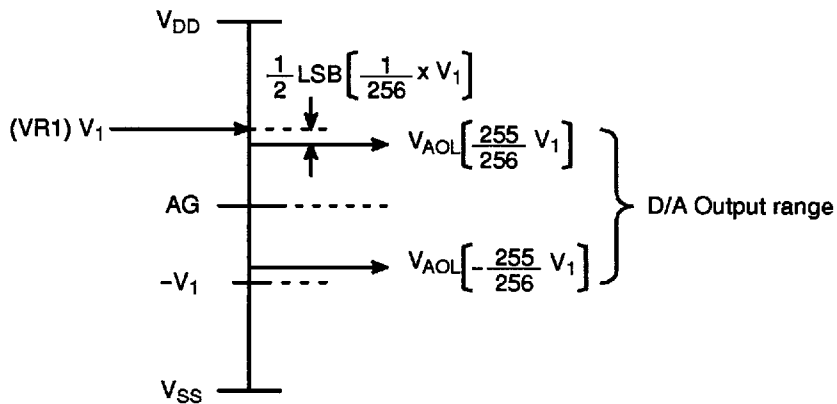
ANALOG OUTPUT VOLTAGE RANGE

Fig. 2 - ON-CHIP REFERENCE VOLTAGE MODE



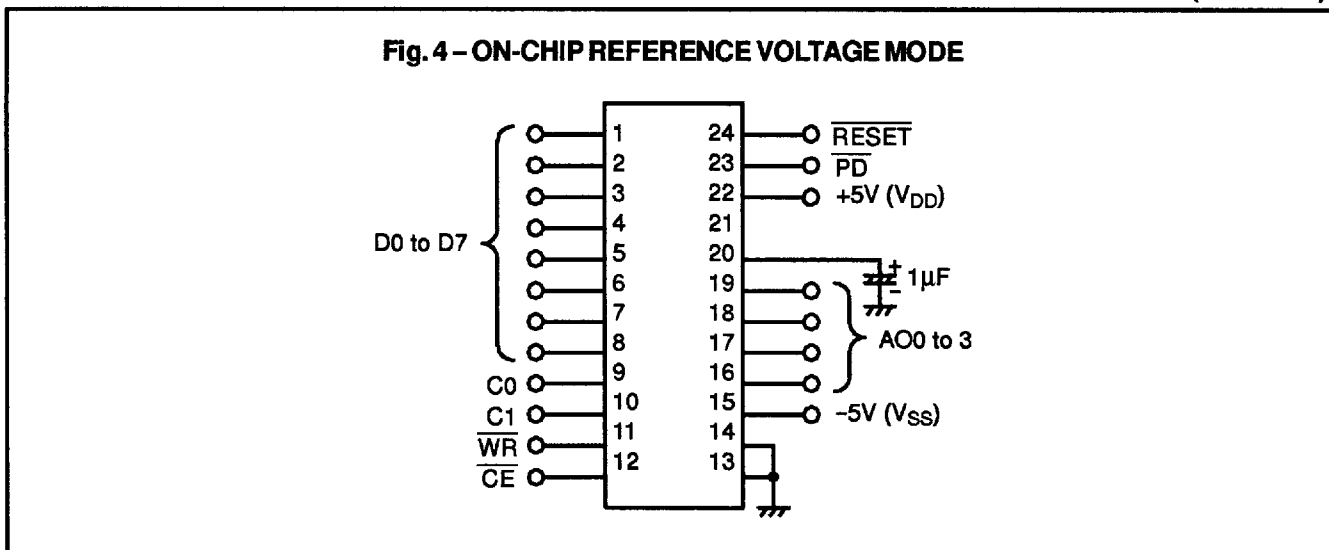
(VR= V_1)

Fig. 3 - EXTERNAL REFERENCE VOLTAGE MODE

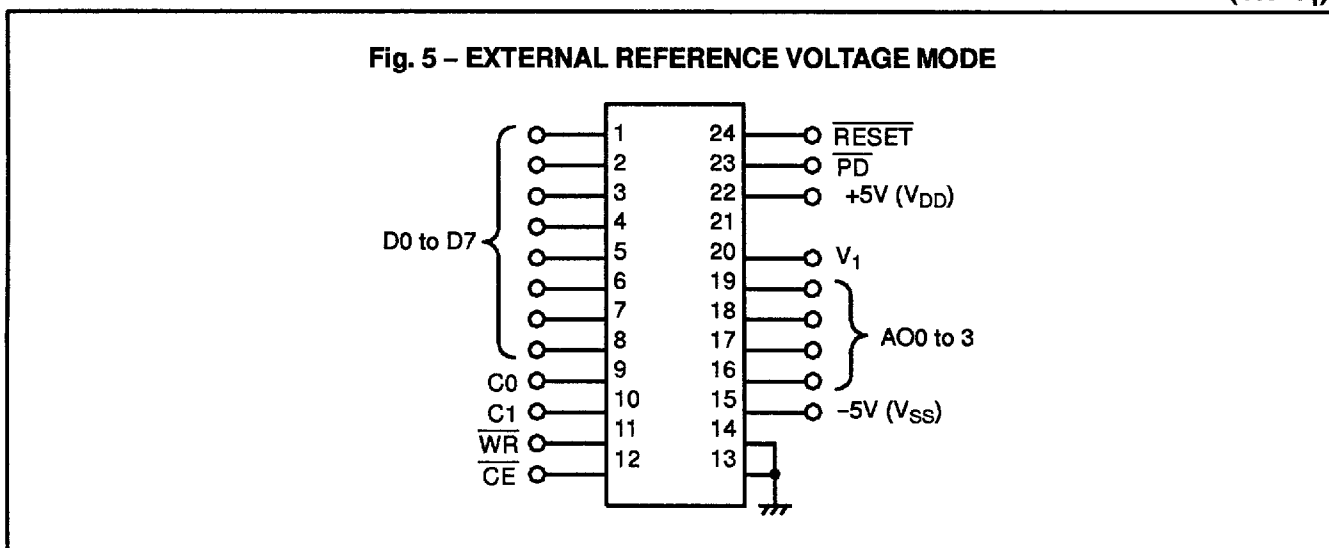


TYPICAL APPLICATION CIRCUIT FOR EACH MODE

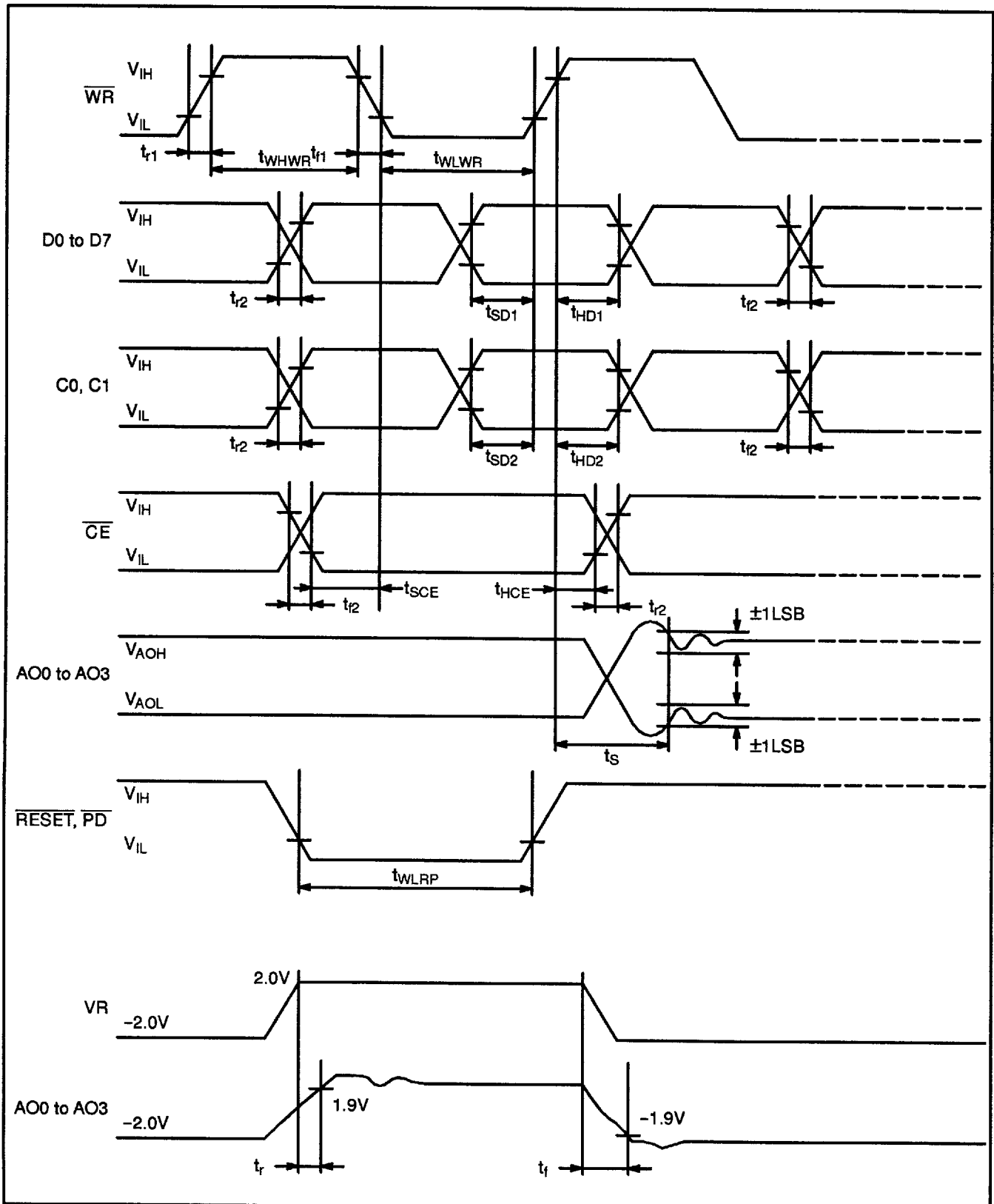
(VR OPEN)



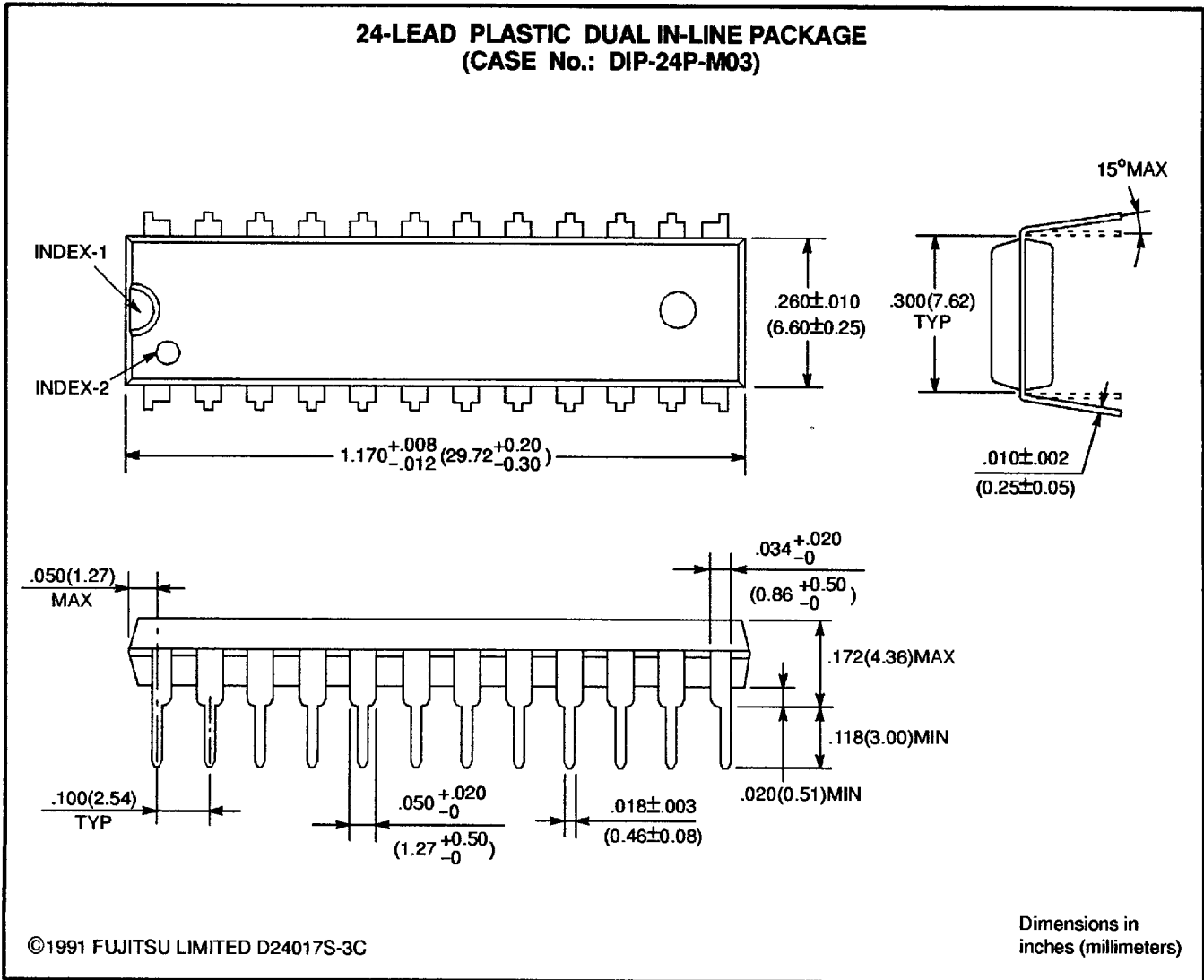
(VR= V_1)

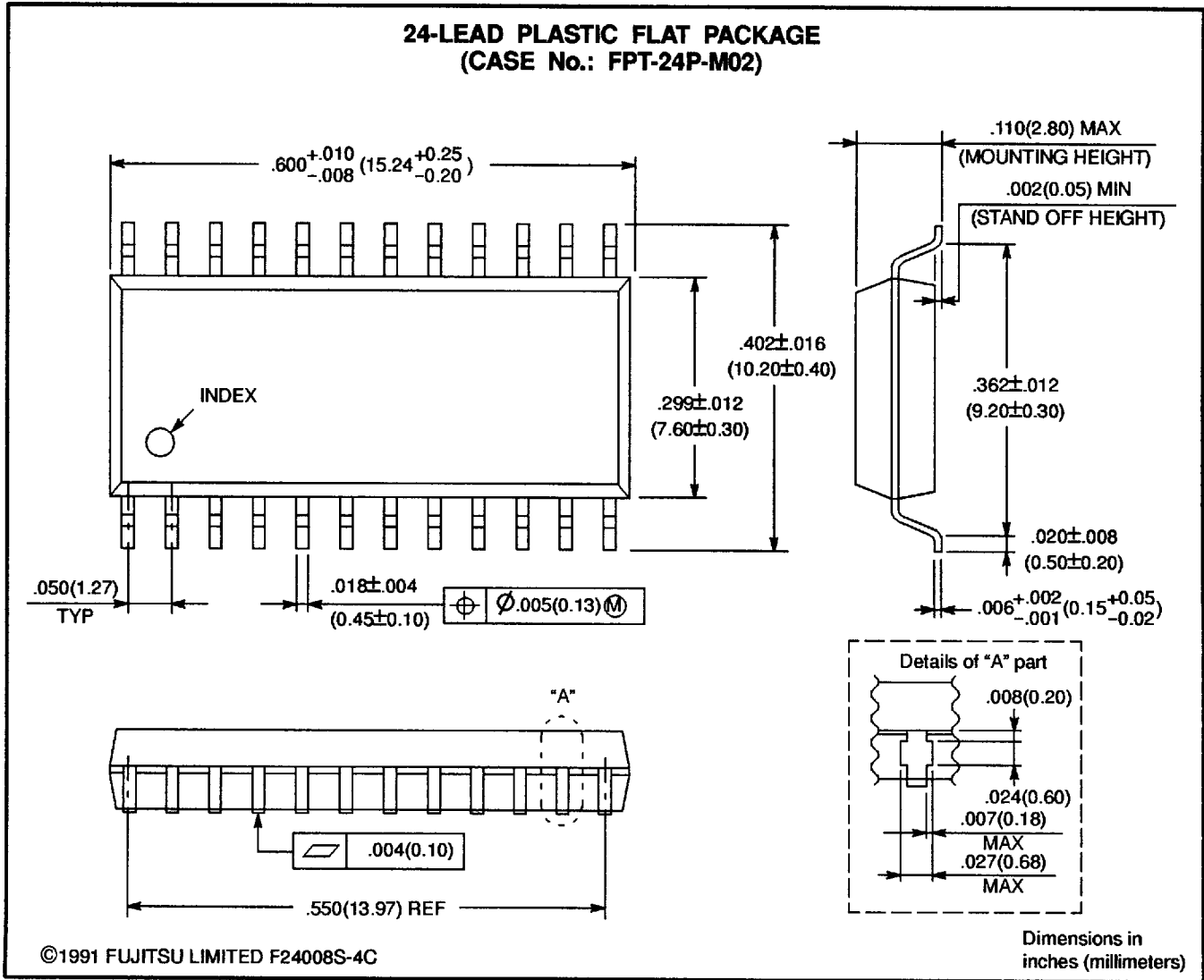


TIMING DIAGRAM



PACKAGE DIMENSIONS





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